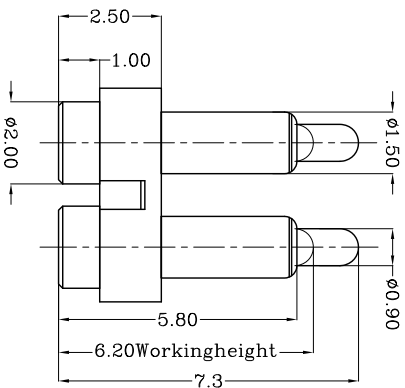
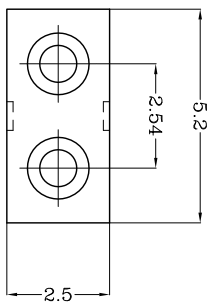
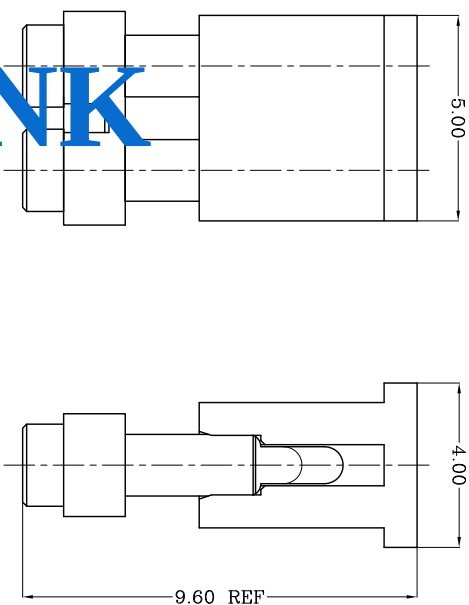


Recommended PCB Layout

Recommended solder patse thickness is 0.10 mm



Notes:

1. Material (材質):

PA 4.6 (30% Glass Filled) Color Black.

Contact: Brass

Spring : Stainless steel wire

2. Platform

Min 0.1um Gold plating over min. 1.4um Nickel plating

(Body: 鍍金0.1 μ m Min 鍍底1.4 μ m Min)

Plunger: Min 0.4um Gold plating over min. 1.4um Nickel plating

(Plunger: 鍍金0.4um Min 鍍底1.4um Min)

3 Mechanical:

Total stroke (总行程): 1.40mm

Durability (寿命): 10,000 cycle min.

4 Electrical(电性能)

Contact resistance(接触抵抗): 30mOhm Max.

Voltage rating(额定电压): 36V DC Max

Current rating(额定电流): 2.5A

100620-2
PART NUMBER

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED	MATL	HT TR	FIN
		—	

DRINK	DOWN	APVD	<i>Top-Link</i> Electronics	Top-Link Electronics Ltd.
0	QIN	REL		
$\pm$				
± 0.15				
± 0.10				
0.00	CHK			
$\pm$				
0.000				
$\pm$				

NEW	SURF. TEXTURE: $3.2/\sqrt{\text{IN}}^2$		NAME	
REVISION RECORD	APVD	DATE	SCALE	DWG
		2010/05/06	A4	NO.
			1:1	C-100620
				SHEET
				1 OF 1
				REV
				1